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**General Information**

Series	CC X6S
Style	SMD Chip
Description	"SMD, MLCC"
Features	Temperature Stable
RoHS	Yes
Termination	Tin
MSL	1

**Dimensions**

L	2mm +/-0.1mm
W	1.25mm +/-0.1mm
B	0.5mm +/-0.25mm
Case Code (EIA / mm)	0805 / 2012

**Packaging Specifications**

Packaging	T&R, 180mm, Plastic Tape
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**Specifications**

Capacitance	22 uF
Tolerance	20%
Voltage DC	10 VDC
Temperature Range	-55/+105°C
Temp. Coefficient	X6S
Dissipation Factor	10%
Insulation Resistance	0 mOhms

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